



FCH47N60F _F133 600V N-Channel MOSFET

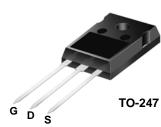
Features

- 650V @T_J = 150°C
- Typ. R_{DS(on)} = 0.062Ω
- Fast Recovery Type (t_{rr} = 240ns)
- Ultra Low Gate Charge (typ. Q_g = 210nC)
- Low Effective Output Capacitance (typ. C_{oss}eff. = 420pF)
- 100% avalanche tested

Description

SuperFETTM is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



Absolute Maximum Ratings

Symbol	Parameter			FCH47N60F	Unit	
V _{DSS}	Drain-Source Voltage		600		V	
ID	Drain Current - Continuous ($T_C = 25^{\circ}C$) - Continuous ($T_C = 100^{\circ}C$))	47 29.7	A A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	141	A	
V _{GSS}	Gate-Source voltage			± 30	V	
E _{AS}	Single Pulsed Avalanche Energy (N		(Note 2)	1800	mJ	
I _{AR}	Avalanche Current		(Note 1)	47	А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	41.7	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	50	V/ns	
P _D	Power Dissipation $(T_C = 25^{\circ}C)$ - Derate above $25^{\circ}C$			417 3.33	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.3	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.24		°C/W
R _{0JA} Thermal Resistance, Junction-to-Ambient			41.7	°C/W

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		Device P		ckageReel SizeTapD-247-		e Width		Quantity 30		
		TC								
Electri	cal Cha	racteristics T _c =	= 25°C unles	ss otherwise no	ted					
Symbo	I	Parameter			Conditions		Min	Тур	Max	Units
Off Chara	cteristics									
BV _{DSS} Drain-Source Breakdown Voltage		$V_{GS} = 0V, I_D = 250\mu A, T_J = 25^{\circ}C$		600			V			
				$V_{GS} = 0V, I_D = 250\mu A, T_J = 150^{\circ}C$			650		V	
ΔBV _{DSS} / ΔT _J			9	$I_D = 250 \mu A$, Referenced to 25°C			0.6		V/°C	
BV _{DS}	Drain-Source Avalanche Breakdown Voltage		lown	V _{GS} = 0V, I _D = 47A			700		V	
I _{DSS}	Zero Gate Voltage Drain Current		t	$V_{DS} = 600V, V_{GS} = 0V$ $V_{DS} = 480V, T_{C} = 125^{\circ}C$				10 100	μΑ μΑ	
I _{GSSF}	Gate-Boo	ly Leakage Current, Fo	orward	$V_{GS} = 30V, V_{DS} = 0V$				100	nA	
I _{GSSR}	Gate-Boo	dy Leakage Current, Reverse		$V_{GS} = -30V, V_{DS} = 0V$				-100	nA	
On Chara	cteristics									
V _{GS(th)}	Gate Threshold Voltage		$V_{DS} = V_{GS}, I_D = 250 \mu A$		3.0		5.0	V		
R _{DS(on)}	Static Dra On-Resis	ain-Source stance		V _{GS} = 10V, I _D = 23.5A			0.062	0.073	Ω	
9 _{FS}	Forward ⁻	Transconductance		V _{DS} = 40V	′, I _D = 23.5A	(Note 4)		40		S
Dynamic	Characteris	stics								
C _{iss}	Input Cap	out Capacitance Itput Capacitance		$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz			5900	8000	pF	
C _{oss}	Output C						3200	4200	pF	
C _{rss}	Reverse	Transfer Capacitance						250		pF
C _{oss}	Output C	Output Capacitance		$V_{DS} = 480V, V_{GS} = 0V, f = 1.0MHz$			160		pF	
C _{oss} eff.	Effective Output Capacitance			$V_{DS} = 0V$ to 400V, $V_{GS} = 0V$			420		pF	
Switching	g Character	istics		-						
t _{d(on)}	Turn-On	rn-On Delay Time		$V_{DD} = 300V, I_D = 47A$			185	430	ns	
t _r	Turn-On	Rise Time		$R_G = 25\Omega$			210	450	ns	
t _{d(off)}	Turn-Off	Delay Time					520	1100	ns	
t _f	Turn-Off	Fall Time				(Note 4, 5)		75	160	ns
Qg	Total Gate	e Charge		$V_{DS} = 480V, I_{D} = 47A$ $V_{GS} = 10V$ (Note 4, 5)			210	270	nC	
Q _{gs}	Gate-Sou	Irce Charge					38		nC	
Q _{gd}		in Charge					110		nC	
Drain-Sou	Irce Diode	Characteristics and N	laximum	Ratings						T
I _S		n Continuous Drain-Sou		de Forward Current				47	А	
I _{SM}	Maximum	Pulsed Drain-Source	Diode Fo	orward Curr	ent				141	Α
V _{SD}	Drain-So	urce Diode Forward Vo	ltage	$V_{GS} = 0V,$	I _S = 47A				1.4	V
t _{rr}	Reverse	Recovery Time		$V_{GS} = 0V,$				240		ns
Q _{rr}	Reverse	Recovery Charge		$dI_F/dt = 10$	dl _F /dt =100A/µs (Note 4)			2.04		μC

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. I_{AS} = 18A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}C$

3. I_{SD} \leq 47A, di/dt \leq 1,200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

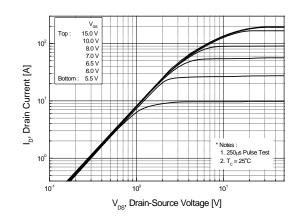
5. Essentially Independent of Operating Temperature Typical Characteristics

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Typical Performance Characteristics



Figure 2. Transfer Characteristics





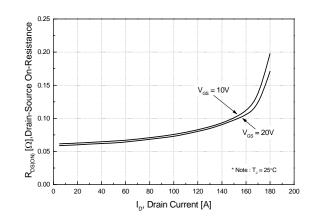
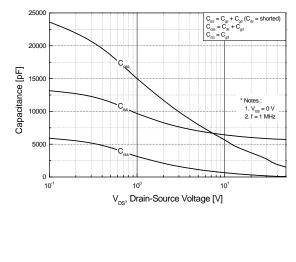
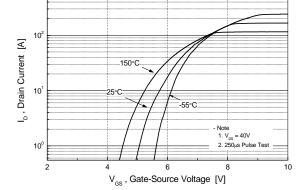


Figure 5. Capacitance Characteristics







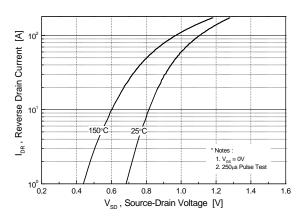
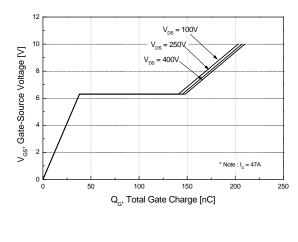
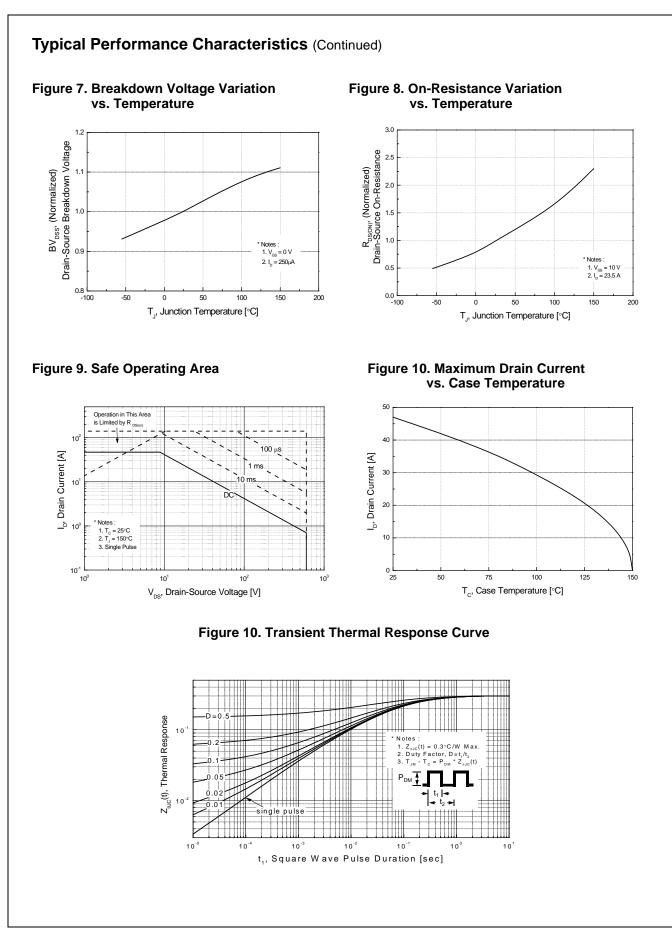
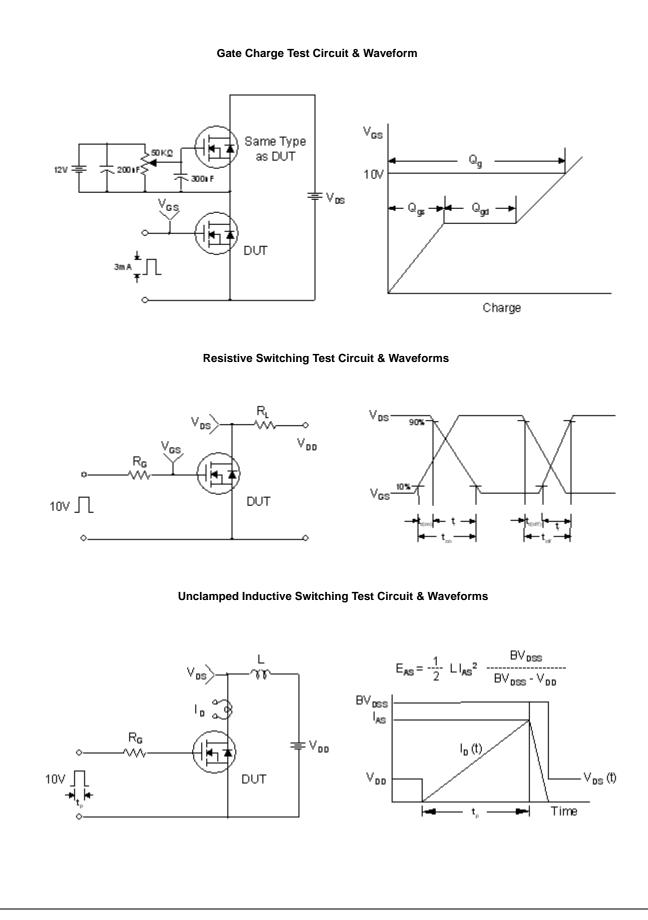


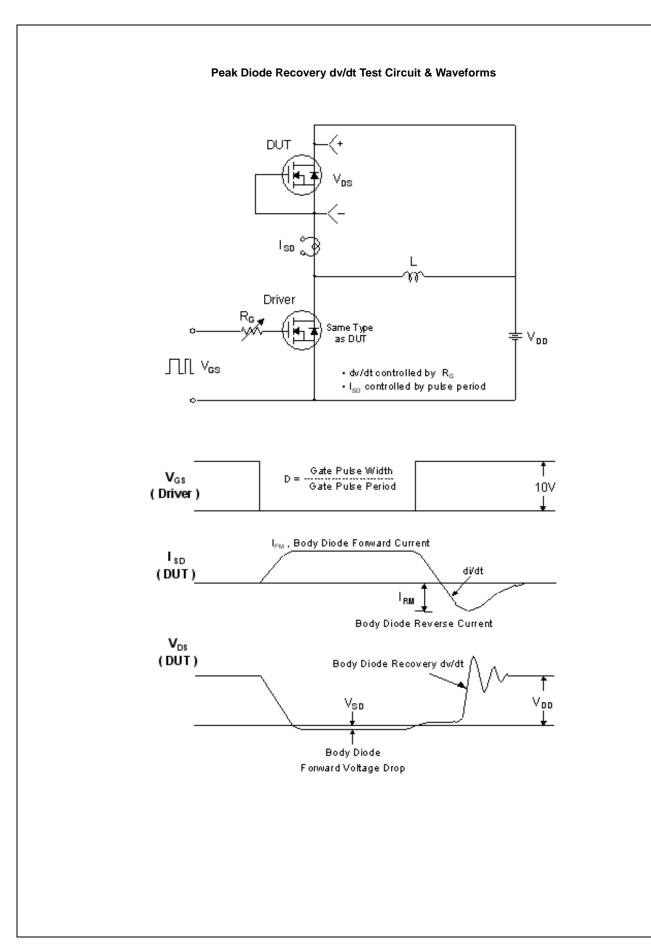
Figure 6. Gate Charge Characteristics

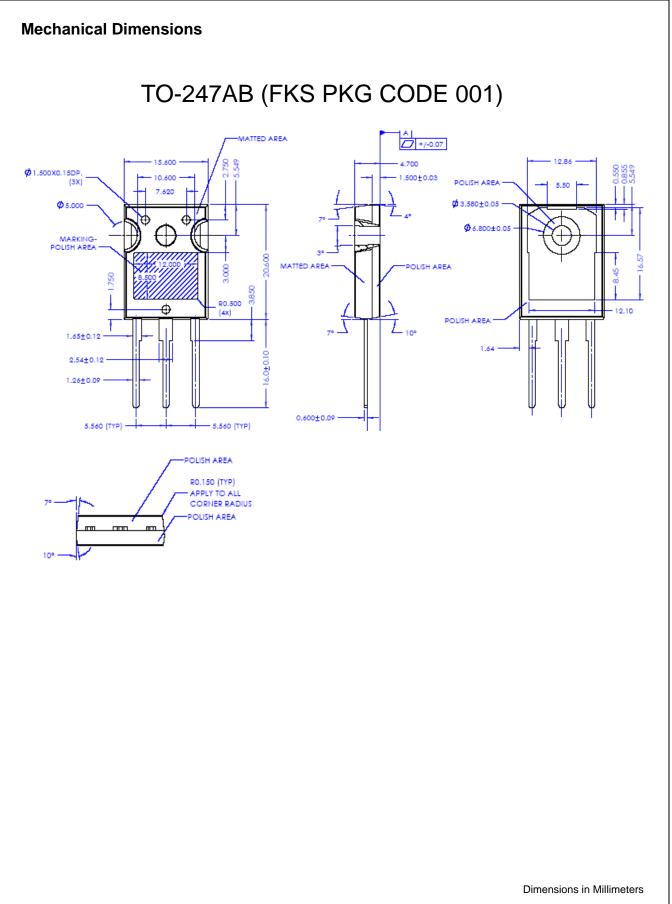






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